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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	28
Program Memory Size	56KB (56K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VQFN Exposed Pad
Supplier Device Package	32-HVQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1114jhn33-333e

- Digital peripherals:
 - ◆ Up to 42 General Purpose I/O (GPIO) pins with configurable pull-up/pull-down resistors. In addition, a configurable open-drain mode is supported on the LPC1100L and LPC1100XL series.
 - ◆ GPIO pins can be used as edge and level sensitive interrupt sources.
 - ◆ High-current output driver (20 mA) on one pin.
 - ◆ High-current sink drivers (20 mA) on two I²C-bus pins in Fast-mode Plus (not on LPC1112FDH20/102).
 - ◆ Four general purpose counter/timers with up to eight capture inputs and up to 13 match outputs.
 - ◆ Programmable WatchDog Timer (WDT) the LPC1100 series only.
 - ◆ Programmable windowed WDT on the LPC1100L and LPC1100XL series only.
- Analog peripherals:
 - ◆ 10-bit ADC with input multiplexing among 5, 6, or 8 pins depending on package size.
- Serial interfaces:
 - ◆ UART with fractional baud rate generation, internal FIFO, and RS-485 support.
 - ◆ Two SPI controllers with SSP features and with FIFO and multi-protocol capabilities (second SPI on LPC1100 and LPC1100L series LQFP48 package only).
 - ◆ I²C-bus interface supporting full I²C-bus specification and Fast-mode Plus with a data rate of 1 Mbit/s with multiple address recognition and monitor mode (not on LPC1112FDH20/102).
- Clock generation:
 - ◆ 12 MHz internal RC oscillator trimmed to 1 % accuracy that can optionally be used as a system clock.
 - ◆ Crystal oscillator with an operating range of 1 MHz to 25 MHz.
 - ◆ Programmable watchdog oscillator with a frequency range of 9.4 kHz to 2.3 MHz.
 - ◆ PLL allows CPU operation up to the maximum CPU rate without the need for a high-frequency crystal. May be run from the system oscillator or the internal RC oscillator.
 - ◆ Clock output function with divider that can reflect the system oscillator clock, IRC clock, CPU clock, and the Watchdog clock.
- Power control:
 - ◆ Integrated PMU (Power Management Unit) to minimize power consumption during Sleep, Deep-sleep, and Deep power-down modes.
 - ◆ Power profiles residing in boot ROM allowing to optimize performance and minimize power consumption for any given application through one simple function call. (LPC1100L and LPC1100XL series only.)
 - ◆ Three reduced power modes: Sleep, Deep-sleep, and Deep power-down.
 - ◆ Processor wake-up from Deep-sleep mode via a dedicated start logic using up to 13 of the functional pins.
 - ◆ Power-On Reset (POR).
 - ◆ Brownout detect with up to four separate thresholds for interrupt and forced reset.
- Unique device serial number for identification.
- Single power supply (1.8 V to 3.6 V).
- Available as LQFP48 package, HVQFN33 package, and TFBGA48 package.

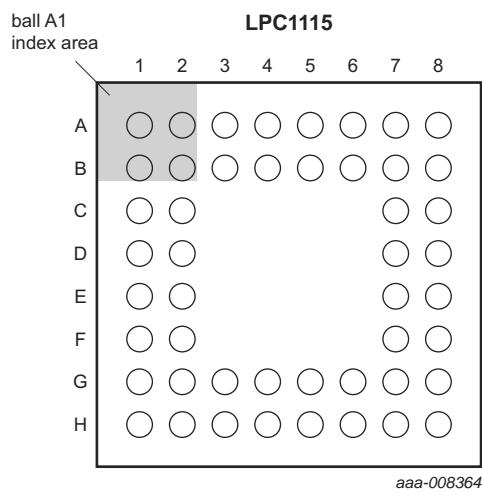


Fig 5. LPC1100XL series pin configuration TFBGA48 package

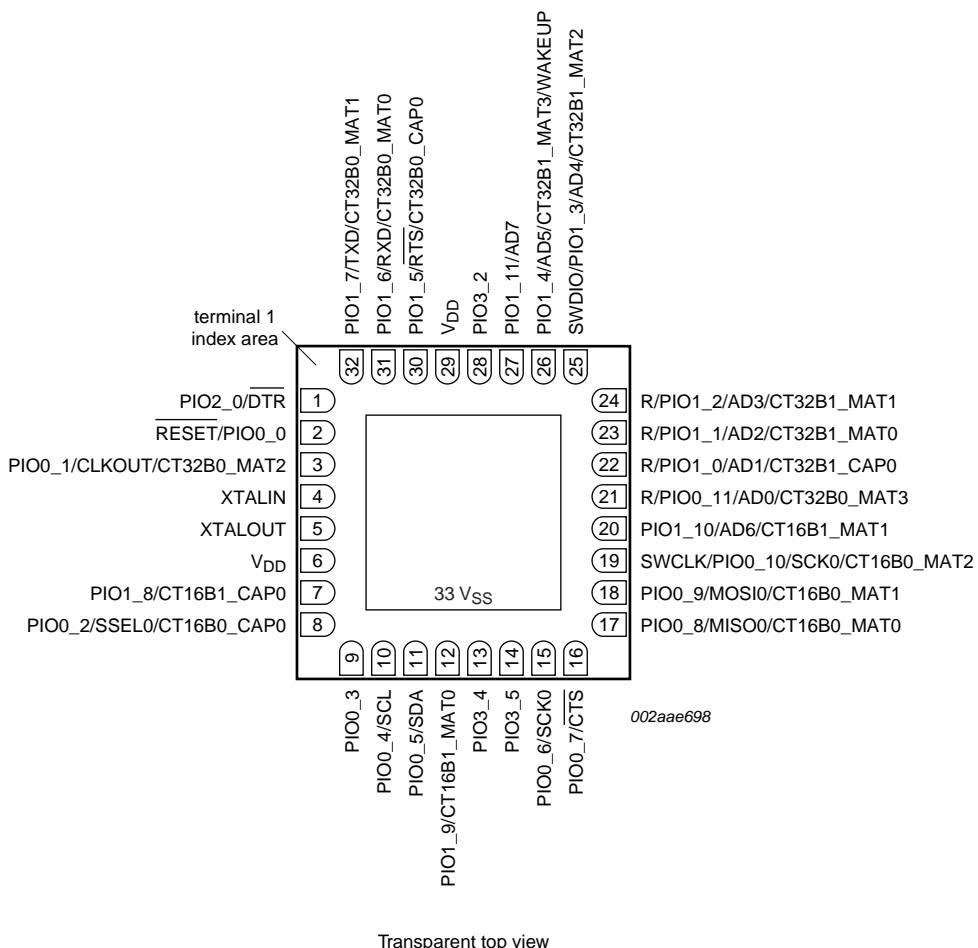


Fig 6. LPC1100 and LPC1100L series pin configuration HVQFN33 7x7 and 5x5 packages

Table 7. LPC1100L series: LPC1112/14 pin description table (TSSOP28 and DIP28 packages) ...continued

Symbol	Pin TSSOP28/ DIP28	Start logic input	Type	Reset state [1]	Description
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	3 [3]	yes	I	I; PU	SWCLK — Serial wire clock.
			I/O	-	PIO0_10 — General purpose digital input/output pin.
			I/O	-	SCK0 — Serial clock for SPI0.
			O	-	CT16B0_MAT2 — Match output 2 for 16-bit timer 0.
R/PIO0_11/ AD0/CT32B0_MAT3	4 [5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO0_11 — General purpose digital input/output pin.
			I	-	AD0 — A/D converter, input 0.
			O	-	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_9			I/O		Port 1 — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	9 [5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_0 — General purpose digital input/output pin.
			I	-	AD1 — A/D converter, input 1.
			I	-	CT32B1_CAP0 — Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	10 [5]	no	O	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_1 — General purpose digital input/output pin.
			I	-	AD2 — A/D converter, input 2.
			O	-	CT32B1_MAT0 — Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	11 [5]	no	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_2 — General purpose digital input/output pin.
			I	-	AD3 — A/D converter, input 3.
			O	-	CT32B1_MAT1 — Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	12 [5]	no	I/O	I; PU	SWDIO — Serial wire debug input/output.
			I/O	-	PIO1_3 — General purpose digital input/output pin.
			I	-	AD4 — A/D converter, input 4.
			O	-	CT32B1_MAT2 — Match output 2 for 32-bit timer 1.
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	13 [5]	no	I/O	I; PU	PIO1_4 — General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
			I	-	AD5 — A/D converter, input 5.
			O	-	CT32B1_MAT3 — Match output 3 for 32-bit timer 1.

Table 7. LPC1100L series: LPC1112/14 pin description table (TSSOP28 and DIP28 packages) ...continued

Symbol	Pin TSSOP28/ DIP28	Start logic input	Type	Reset state [1]	Description
PIO1_5/RTS/ CT32B0_CAP0	14 [3]	no	I/O	I; PU	PIO1_5 — General purpose digital input/output pin.
			O	-	RTS — Request To Send output for UART.
			I	-	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.
PIO1_6/RXD/ CT32B0_MAT0	15 [3]	no	I/O	I; PU	PIO1_6 — General purpose digital input/output pin.
			I	-	RXD — Receiver input for UART.
			O	-	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	16 [3]	no	I/O	I; PU	PIO1_7 — General purpose digital input/output pin.
			O	-	TXD — Transmitter output for UART.
			O	-	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	17 [3]	no	I/O	I; PU	PIO1_8 — General purpose digital input/output pin.
			I	-	CT16B1_CAP0 — Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	18 [3]	no	I/O	I; PU	PIO1_9 — General purpose digital input/output pin.
			O	-	CT16B1_MAT0 — Match output 0 for 16-bit timer 1.
V _{DD}	21	-	-	-	3.3 V supply voltage to the internal regulator and the external rail.
V _{DDA}	7	-	-	-	3.3 V supply voltage to the ADC. Also used as the ADC reference voltage.
XTALIN	20 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	19 [6]	-	O	-	Output from the oscillator amplifier.
V _{SS}	22	-	-	-	Ground.
V _{SSA}	8	-	-	-	Analog ground.

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V_{DD} level); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. **RESET** functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I²C-bus pads compliant with the I²C-bus specification for I²C standard mode and I²C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I²C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see [Figure 51](#)).
- [6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 8. LPC1100 and LPC1100L series: LPC1113/14 pin description table (LQFP48 package)

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11			I/O		Port 0 — Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
RESET/PIO0_0	3[2]	yes	I	I; PU	RESET — External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed and Deep power-down mode is not used.
			I/O	-	PIO0_0 — General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/CT32B0_MAT2	4[3]	yes	I/O	I; PU	PIO0_1 — General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	CLKOUT — Clockout pin.
			O	-	CT32B0_MAT2 — Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/CT16B0_CAP0	10[3]	yes	I/O	I; PU	PIO0_2 — General purpose digital input/output pin.
			I/O	-	SSEL0 — Slave Select for SPI0.
			I	-	CT16B0_CAP0 — Capture input 0 for 16-bit timer 0.
PIO0_3	14[3]	yes	I/O	I; PU	PIO0_3 — General purpose digital input/output pin.
PIO0_4/SCL	15[4]	yes	I/O	I; IA	PIO0_4 — General purpose digital input/output pin (open-drain).
			I/O	-	SCL — I ² C-bus, open-drain clock input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	16[4]	yes	I/O	I; IA	PIO0_5 — General purpose digital input/output pin (open-drain).
			I/O	-	SDA — I ² C-bus, open-drain data input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	22[3]	yes	I/O	I; PU	PIO0_6 — General purpose digital input/output pin.
			I/O	-	SCK0 — Serial clock for SPI0.
PIO0_7/CTS	23[3]	yes	I/O	I; PU	PIO0_7 — General purpose digital input/output pin (high-current output driver).
			I	-	CTS — Clear To Send input for UART.
PIO0_8/MISO0/CT16B0_MAT0	27[3]	yes	I/O	I; PU	PIO0_8 — General purpose digital input/output pin.
			I/O	-	MISO0 — Master In Slave Out for SPI0.
			O	-	CT16B0_MAT0 — Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/CT16B0_MAT1	28[3]	yes	I/O	I; PU	PIO0_9 — General purpose digital input/output pin.
			I/O	-	MOSI0 — Master Out Slave In for SPI0.
			O	-	CT16B0_MAT1 — Match output 1 for 16-bit timer 0.

Table 11. LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package) ...continued

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
R/PIO0_11/AD0/ CT32B0_MAT3	21[5]	yes	-	I;PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO0_11 — General purpose digital input/output pin.
			I	-	AD0 — A/D converter, input 0.
			O	-	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_11					Port 1 — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/AD1/ CT32B1_CAP0	22[5]	yes	-	I;PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_0 — General purpose digital input/output pin.
			I	-	AD1 — A/D converter, input 1.
			I	-	CT32B1_CAP0 — Capture input 0 for 32-bit timer 1.
R/PIO1_1/AD2/ CT32B1_MAT0	23[5]	no	-	I;PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_1 — General purpose digital input/output pin.
			I	-	AD2 — A/D converter, input 2.
			O	-	CT32B1_MAT0 — Match output 0 for 32-bit timer 1.
R/PIO1_2/AD3/ CT32B1_MAT1	24[5]	no	-	I;PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_2 — General purpose digital input/output pin.
			I	-	AD3 — A/D converter, input 3.
			O	-	CT32B1_MAT1 — Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	25[5]	no	I/O	I;PU	SWDIO — Serial wire debug input/output.
			I/O	-	PIO1_3 — General purpose digital input/output pin.
			I	-	AD4 — A/D converter, input 4.
			O	-	CT32B1_MAT2 — Match output 2 for 32-bit timer 1.
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	26[5]	no	I/O	I;PU	PIO1_4 — General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
			I	-	AD5 — A/D converter, input 5.
			O	-	CT32B1_MAT3 — Match output 3 for 32-bit timer 1.
PIO1_5/RTS/ CT32B0_CAP0	30[3]	no	I/O	I;PU	PIO1_5 — General purpose digital input/output pin.
			O	-	RTS — Request To Send output for UART.
			I	-	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.
PIO1_6/RXD/ CT32B0_MAT0	31[3]	no	I/O	I;PU	PIO1_6 — General purpose digital input/output pin.
			I	-	RXD — Receiver input for UART.
			O	-	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.

7. Functional description

7.1 ARM Cortex-M0 processor

The ARM Cortex-M0 is a general purpose, 32-bit microprocessor, which offers high performance and very low power consumption.

7.2 On-chip flash program memory

The LPC1110/11/12/13/14/15 contain 64 kB (LPC1115), 56 kB (LPC1114/333), 48 kB (LPC1114/323), 32 kB (LPC1114), 24 kB (LPC1113), 16 kB (LPC1112), 8 kB (LPC1111) or 4 kB (LPC1110) of on-chip flash memory.

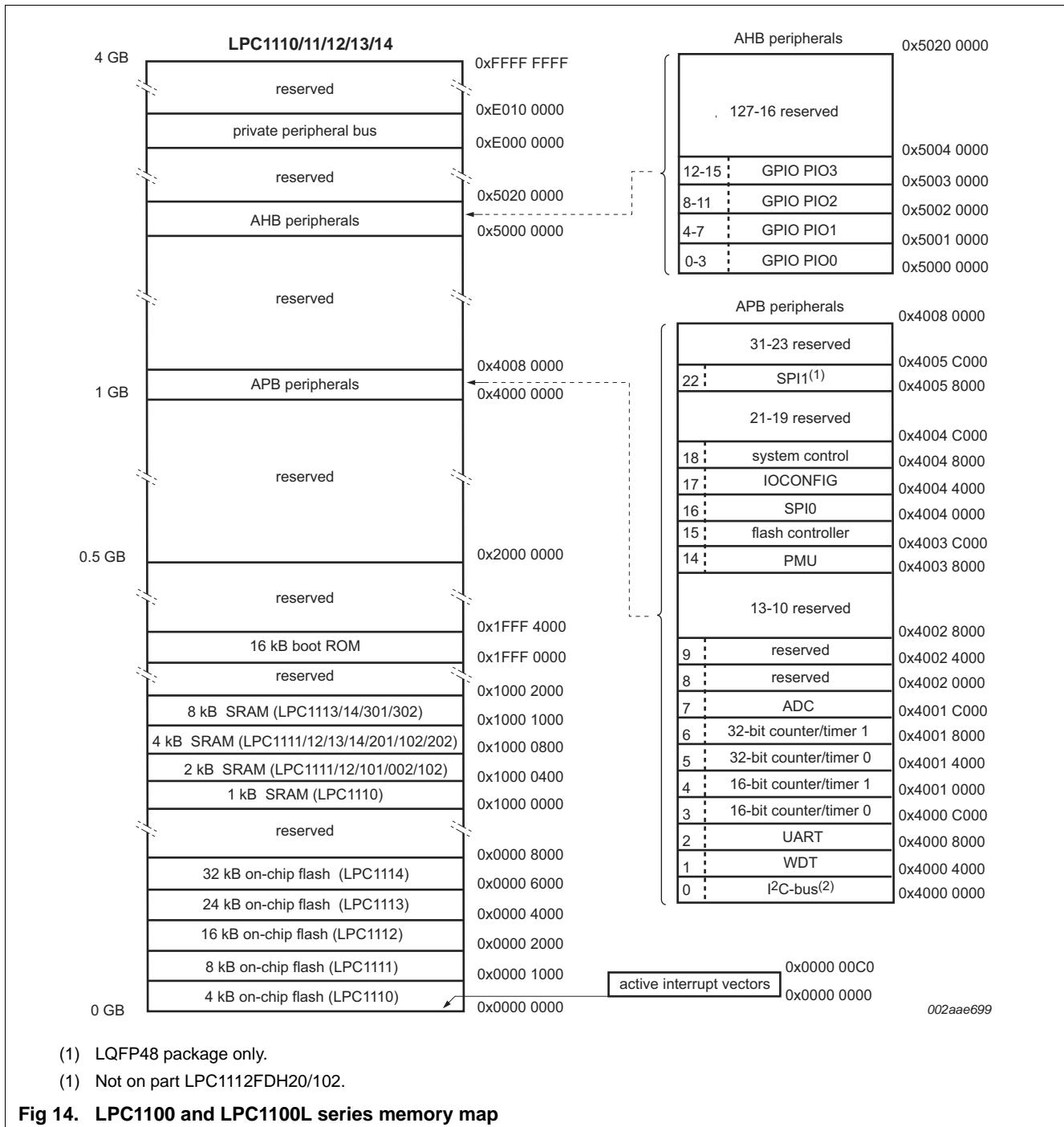
7.3 On-chip SRAM

The LPC1110/11/12/13/14/15 contain a total of 8 kB, 4 kB, 2 kB, or 1 kB on-chip static RAM memory.

7.4 Memory map

The LPC1110/11/12/13/14/15 incorporate several distinct memory regions, shown in the following figures. [Figure 14](#) shows the overall map of the entire address space from the user program viewpoint following reset. The interrupt vector area supports address remapping.

The AHB peripheral area is 2 MB in size, and is divided to allow for up to 128 peripherals. The APB peripheral area is 512 kB in size and is divided to allow for up to 32 peripherals. Each peripheral of either type is allocated 16 kB of space. This allows simplifying the address decoding for each peripheral.



- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from ($T_{cy(WDCLK)} \times 256 \times 4$) to ($T_{cy(WDCLK)} \times 2^{24} \times 4$) in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the Internal RC oscillator (IRC), the Watchdog oscillator, or the main clock. This gives a wide range of potential timing choices of Watchdog operation under different power reduction conditions. It also provides the ability to run the WDT from an entirely internal source that is not dependent on an external crystal and its associated components and wiring for increased reliability.

7.15 Windowed WatchDog Timer (LPC1100L and LPC1100XL series)

Remark: The windowed watchdog timer is available on the LPC1100L and LPC1100XL series only.

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

7.15.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect feed sequence causes reset or interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from ($T_{cy(WDCLK)} \times 256 \times 4$) to ($T_{cy(WDCLK)} \times 2^{24} \times 4$) in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the IRC or the dedicated watchdog oscillator (WDO). This gives a wide range of potential timing choices of watchdog operation under different power conditions.

7.16 Clocking and power control

7.16.1 Crystal oscillators

The LPC1110/11/12/13/14/15 include three independent oscillators. These are the system oscillator, the Internal RC oscillator (IRC), and the Watchdog oscillator. Each oscillator can be used for more than one purpose as required in a particular application.

Table 16. Static characteristics (LPC1100, LPC1100L series) ...continued
 $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
Standard port pins, RESET						
I _{IL}	LOW-level input current	V _I = 0 V; on-chip pull-up resistor disabled	-	0.5	10	nA
I _{IH}	HIGH-level input current	V _I = V _{DD} ; on-chip pull-down resistor disabled	-	0.5	10	nA
I _{OZ}	OFF-state output current	V _O = 0 V; V _O = V _{DD} ; on-chip pull-up/down resistors disabled	-	0.5	10	nA
V _I	input voltage	pin configured to provide a digital function [12][13] [14]	0	-	5.0	V
V _O	output voltage	output active	0	-	V _{DD}	V
V _{IH}	HIGH-level input voltage		0.7V _{DD}	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.3V _{DD}	V
V _{hys}	hysteresis voltage		-	0.4	-	V
V _{OH}	HIGH-level output voltage	2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OH} = -4 mA	V _{DD} - 0.4	-	-	V
		1.8 V ≤ V _{DD} < 2.5 V; I _{OH} = -3 mA	V _{DD} - 0.4	-	-	V
V _{OL}	LOW-level output voltage	2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OL} = 4 mA	-	-	0.4	V
		1.8 V ≤ V _{DD} < 2.5 V; I _{OL} = 3 mA	-	-	0.4	V
I _{OH}	HIGH-level output current	V _{OH} = V _{DD} - 0.4 V; 2.5 V ≤ V _{DD} ≤ 3.6 V	-4	-	-	mA
		1.8 V ≤ V _{DD} < 2.5 V	-3	-	-	mA
I _{OL}	LOW-level output current	V _{OL} = 0.4 V 2.5 V ≤ V _{DD} ≤ 3.6 V	4	-	-	mA
		1.8 V ≤ V _{DD} < 2.5 V	3	-	-	mA
I _{OHS}	HIGH-level short-circuit output current	V _{OH} = 0 V [15]	-	-	-45	mA
I _{OLS}	LOW-level short-circuit output current	V _{OL} = V _{DD} [15]	-	-	50	mA
I _{pd}	pull-down current	V _I = 5 V	10	50	150	μA
I _{pu}	pull-up current	V _I = 0 V; 2.0 V ≤ V _{DD} ≤ 3.6 V	-15	-50	-85	μA
		1.8 V ≤ V _{DD} < 2.0 V	-10	-50	-85	μA
		V _{DD} < V _I < 5 V	0	0	0	μA
High-drive output pin (PIO0_7)						
I _{IL}	LOW-level input current	V _I = 0 V; on-chip pull-up resistor disabled	-	0.5	10	nA
I _{IH}	HIGH-level input current	V _I = V _{DD} ; on-chip pull-down resistor disabled	-	0.5	10	nA

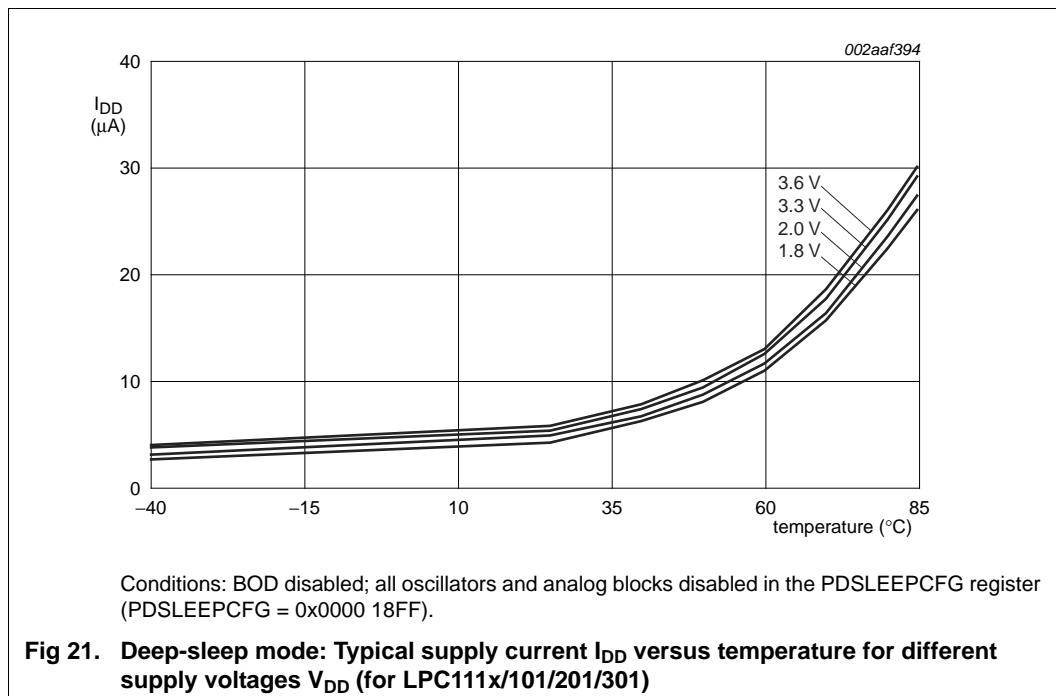


Fig 21. Deep-sleep mode: Typical supply current I_{DD} versus temperature for different supply voltages V_{DD} (for LPC111x/101/201/301)

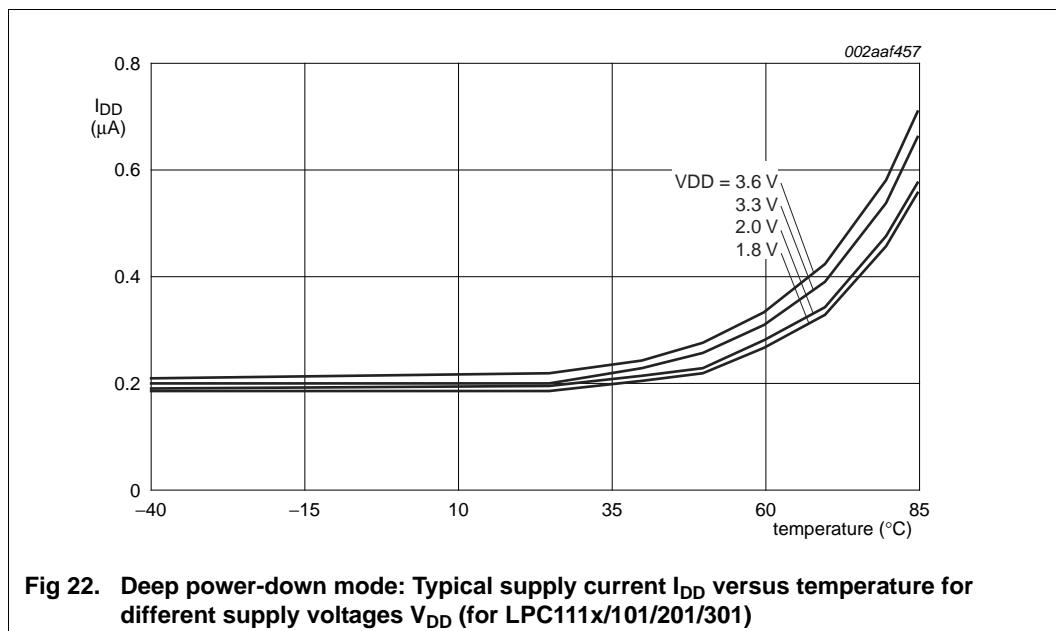
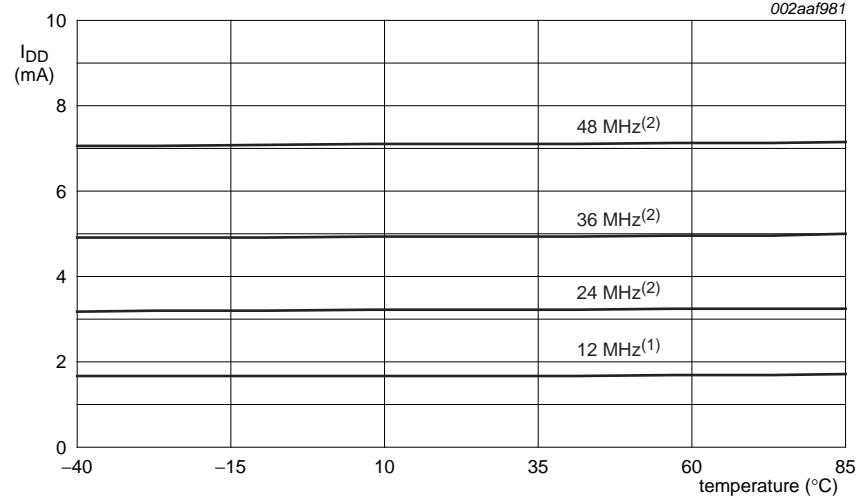


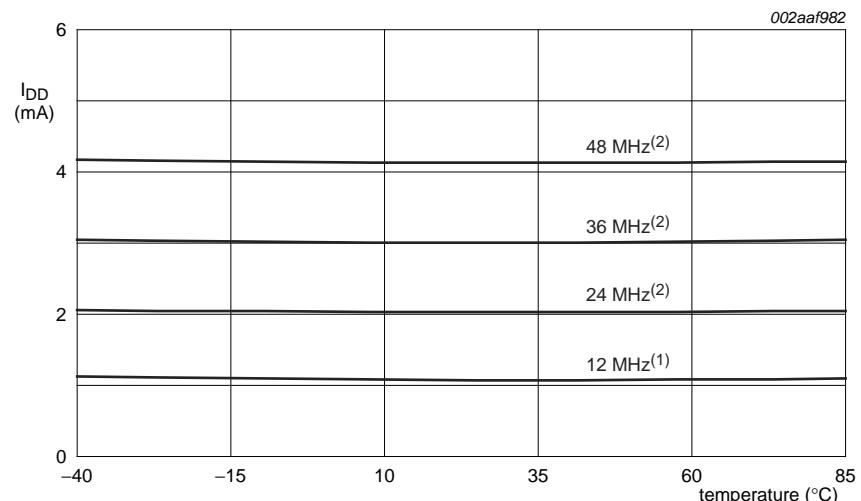
Fig 22. Deep power-down mode: Typical supply current I_{DD} versus temperature for different supply voltages V_{DD} (for LPC111x/101/201/301)



Conditions: $V_{DD} = 3.3$ V; active mode entered executing code while(1){ } from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled; low-current mode.

- (1) System oscillator and system PLL disabled; IRC enabled.
- (2) System oscillator and system PLL enabled; IRC disabled.

Fig 24. Active mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/002/102/202/302)



Conditions: $V_{DD} = 3.3$ V; sleep mode entered from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled; low-current mode.

- (1) System oscillator and system PLL disabled; IRC enabled.
- (2) System oscillator and system PLL enabled; IRC disabled.

Fig 25. Sleep mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/002/102/202/302)

Table 26. Dynamic characteristics: Watchdog oscillator

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
$f_{osc(int)}$	internal oscillator frequency	DIVSEL = 0x1F, FREQSEL = 0x1 [2][3] in the WDTOSCCTRL register;	-	9.4	-	kHz
		DIVSEL = 0x00, FREQSEL = 0xF [2][3] in the WDTOSCCTRL register	-	2300	-	kHz

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The typical frequency spread over processing and temperature ($T_{amb} = -40$ °C to +105 °C) is ±40 %.

[3] See the LPC111x user manual.

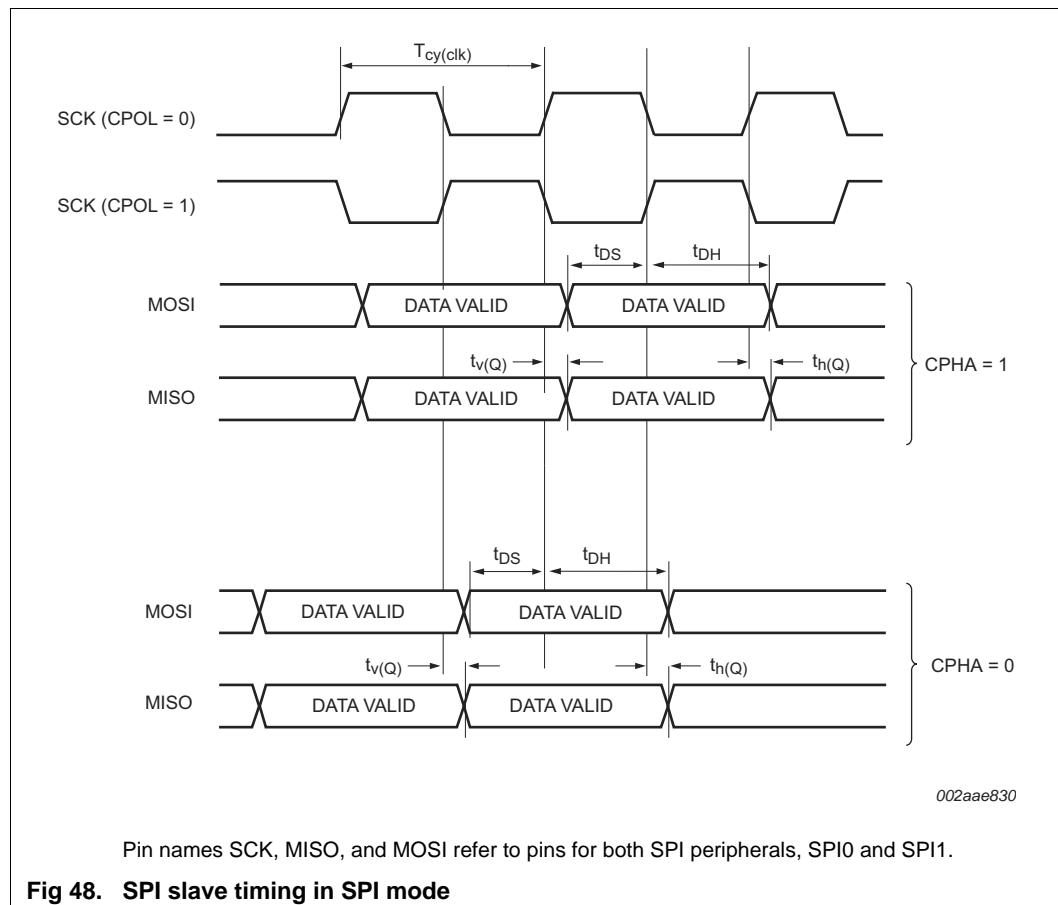
11.5 I/O pins

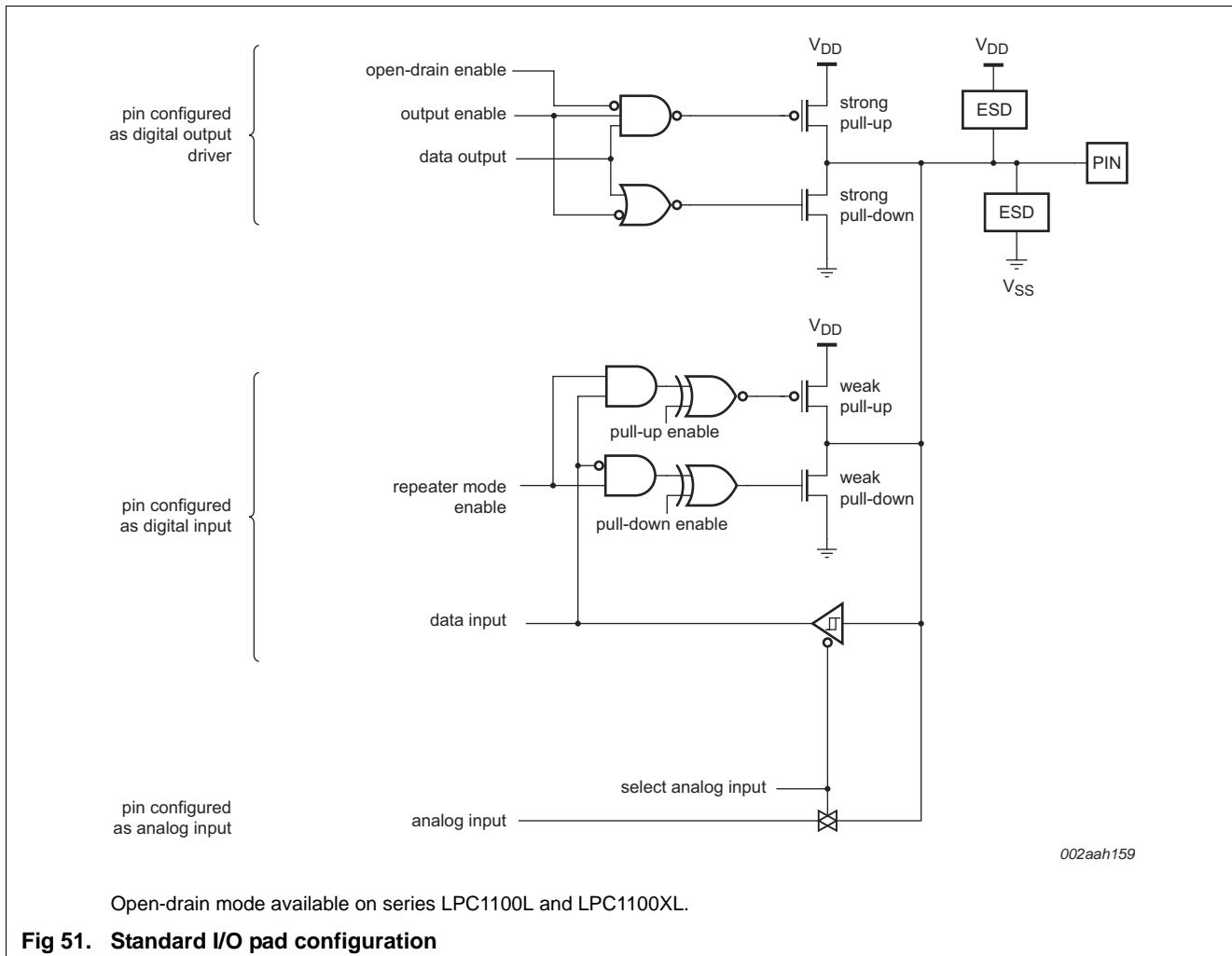
Table 27. Dynamic characteristic: I/O pins^[1]

$T_{amb} = -40$ °C to +105 °C; 3.0 V ≤ V_{DD} ≤ 3.6 V.

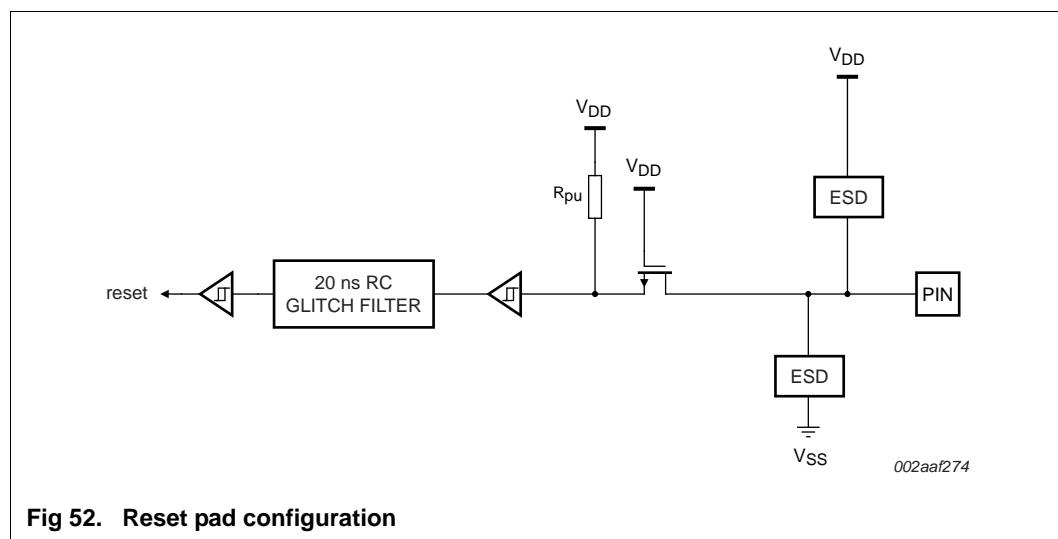
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_r	rise time	pin configured as output	3.0	-	5.0	ns
t_f	fall time	pin configured as output	2.5	-	5.0	ns

[1] Applies to standard port pins and \overline{RESET} pin.





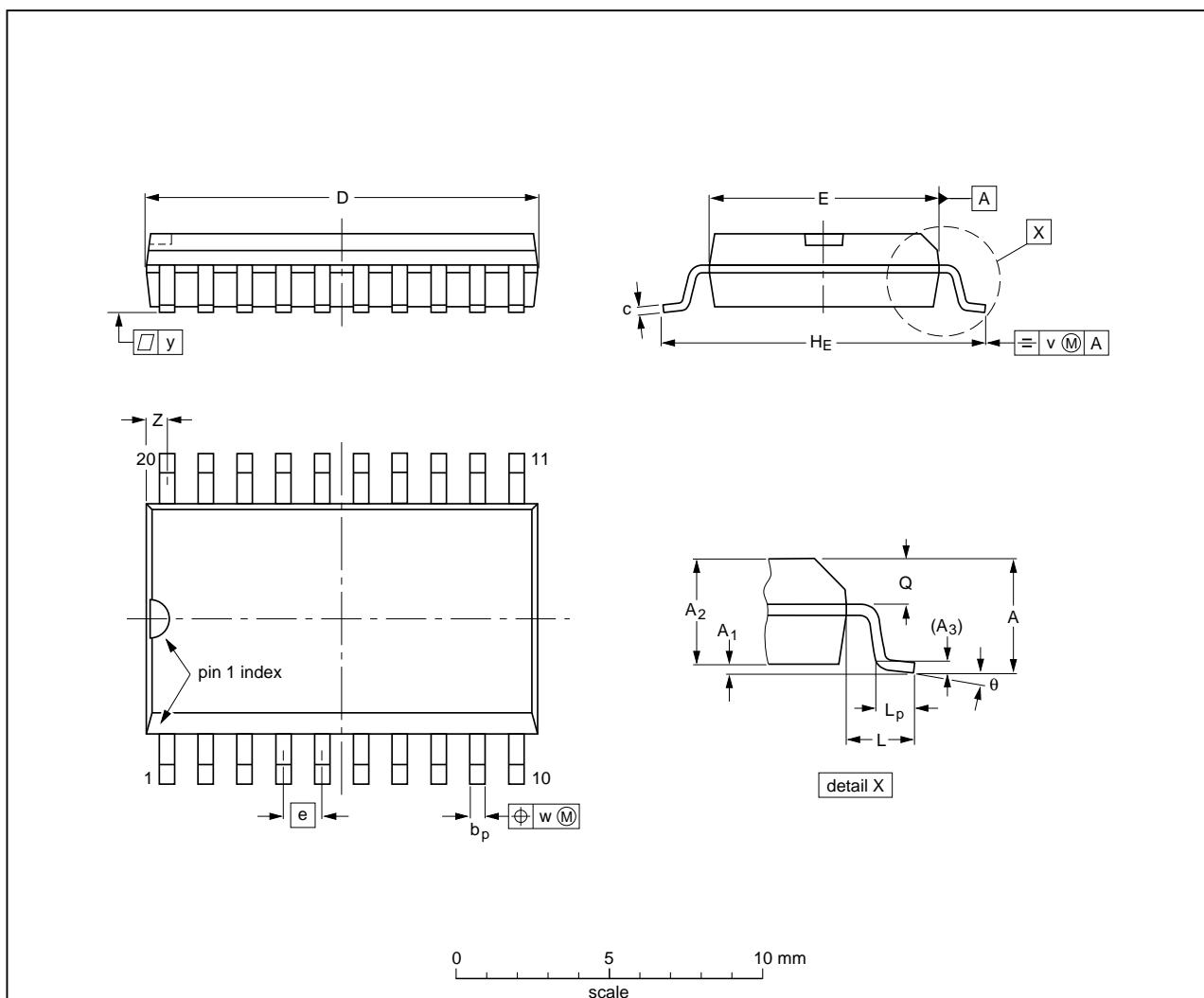
12.6 Reset pad configuration



13. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.65 0.1	0.3 2.25	2.45	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.1 0.004	0.012 0.089	0.096	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0° 0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig 54. Package outline SOT163-1 (SO20)

TFBGA48: plastic thin fine-pitch ball grid array package; 48 balls; body 4.5 x 4.5 x 0.7 mm

SOT1155-2

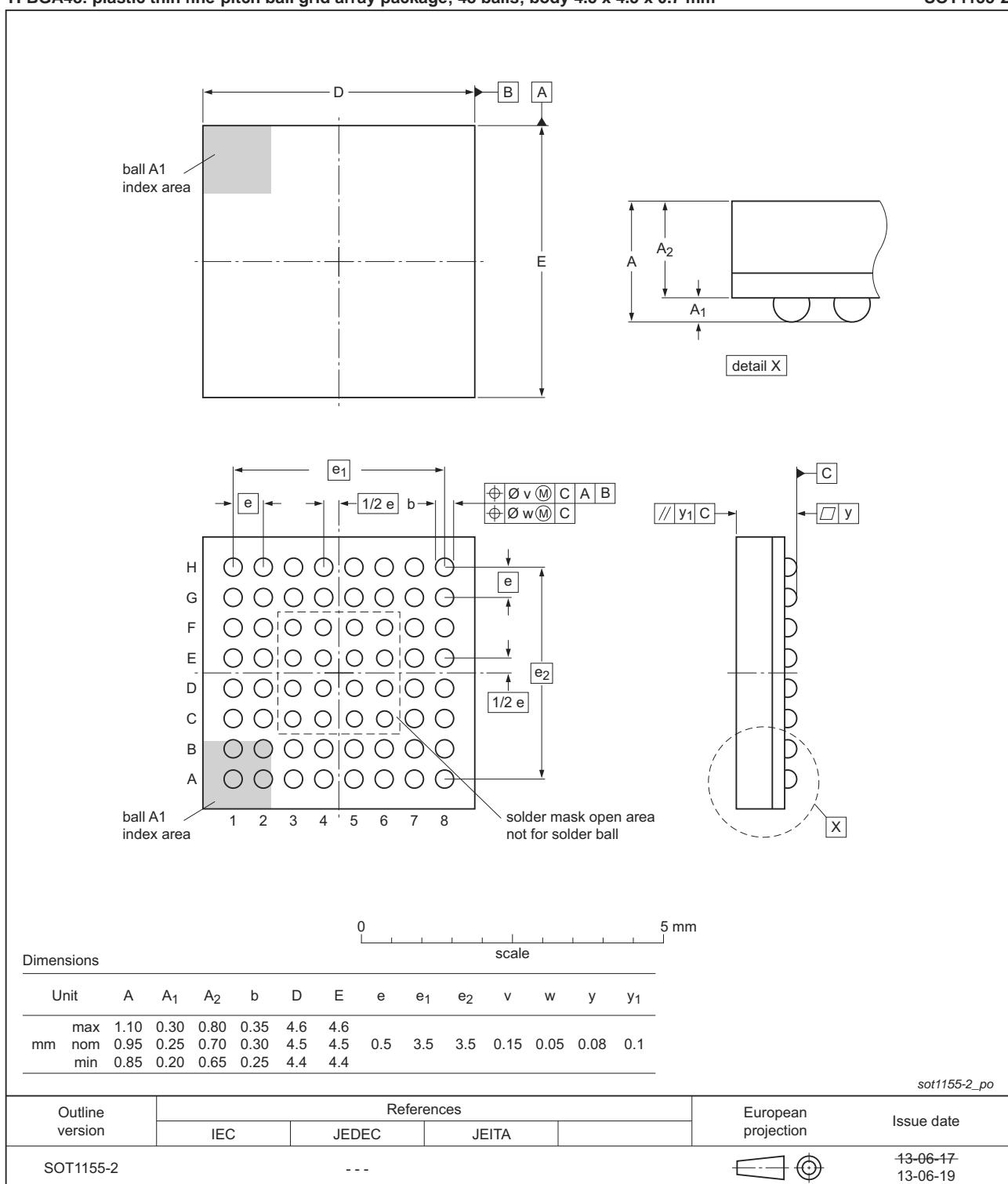
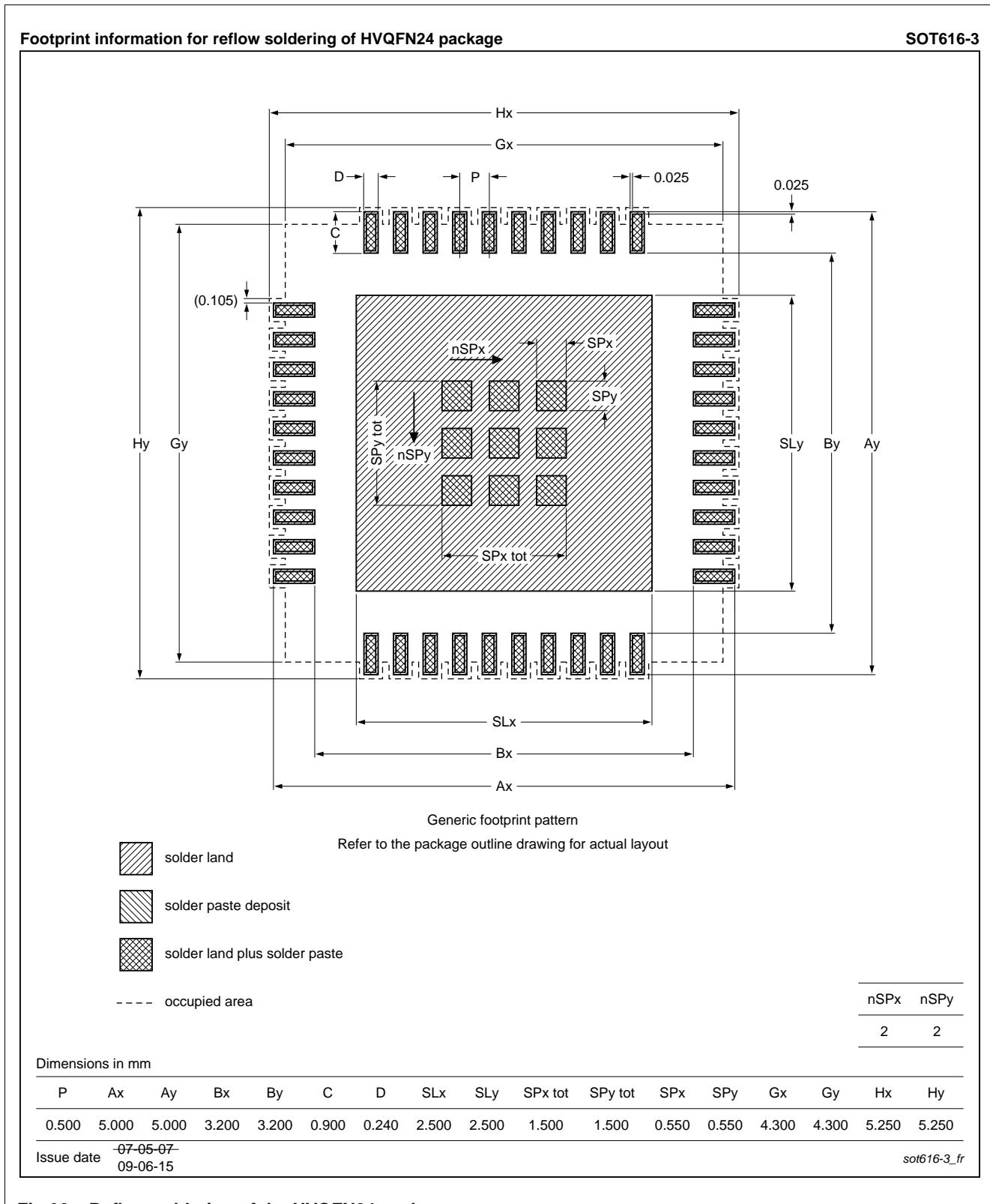


Fig 62. Package outline TFBGA48 (SOT1155-2)

**Fig 66. Reflow soldering of the HVQFN24 package**

15. Abbreviations

Table 33. Abbreviations

Acronym	Description
ADC	Analog-to-Digital Converter
AHB	Advanced High-performance Bus
APB	Advanced Peripheral Bus
BOD	BrownOut Detection
GPIO	General Purpose Input/Output
PLL	Phase-Locked Loop
RC	Resistor-Capacitor
SPI	Serial Peripheral Interface
SSI	Serial Synchronous Interface
SSP	Synchronous Serial Port
TEM	Transverse ElectroMagnetic
UART	Universal Asynchronous Receiver/Transmitter

16. References

- [1] LPC111x/LPC11Cxx User manual UM10398:
http://www.nxp.com/documents/user_manual/UM10398.pdf
- [2] LPC111x Errata sheet:
http://www.nxp.com/documents/errata_sheet/ES_LPC111X.pdf

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